

Bluetooth® Audio Modules BTM510/511 – Firmware Release v22.2.5.0



The BTM510 and BTM511 low-power Bluetooth® modules from Laird are designed for adding robust audio and voice capabilities. Based on the market-leading Cambridge Silicon Radio BC05 chipset, these modules provide exceptionally low power consumption with outstanding range. Supporting the latest Bluetooth Version v3.0 specification, these modules provide the important advantage of Simple Secure Pairing that improves security and enhances easy use. BTM510 and BTM511 modules come standard with the apt-X[™] audio codec for wireline-quality stereo audio.

The modules' compact size makes them ideal for battery-powered headset form factor audio and voice devices. With a 16-bit stereo codec and microphone inputs to support stereo and mono applications, the modules contain a fully integrated Bluetooth-qualified stack along with SPP, HFP 1.6, HSP, AVRCP v1.5, and A2DP profiles.

The BTM510/511 modules include an embedded 32-bit, 64-MIPS DSP core within the BC05. This allows designers to make use of features such as echo cancellation and noise reduction using CSR Clear Voice Capture (CVC) as well as A2DP audio enhancements using CSR Music Manager.

BTM510 and BTM511 modules are provided with CSR's apt-X codec without additional license fees. CSR's world renowned apt-X[™] audio compression solutions retain the full integrity of original digital audio and are optimized for instant real-time audio streaming (http://www.csr.com/products/technology/aptx).

To speed product development and integration, Laird has developed a comprehensive AT command interface that simplifies application development, including support for audio and headset functionality. Combined with a low-cost development kit, Laird's Bluetooth modules provide faster time to market.

Features and Benefits 🚯 🗹 Rolls

- Fully featured Bluetooth multimedia chipset
- Bluetooth v3.0
- Supports mono / stereo headset applications
- apt-X Audio Codec provided free of charge
- Adaptive frequency hopping to cope with interference from other wireless devices
- 32-bit Kalimba DSP for enhanced audio applications
- Support for secure simple pairing
- External or internal antenna options
- HSP and A2DP audio profiles
- HFP v1.6 Wideband Speech and AVRCPv1.5
- 16-bit stereo codec and microphone input
- AptX, AAC and SBC codecs supported
- CVC 7th gen. audio enhancement supported
- EIR fully supported
- Integrated audio amplifiers for driving stereo speaker
- Comprehensive AT interface for simple programming
- Bluetooth End Product qualified
- Compact size
- Class 2 output 4 dBm
- Low power operation
- WLAN co-existence hardware support

Application Areas

- High-quality stereo headsets
- Mono voice headsets
- Hands-free devices
- Wireless audio cable replacement
- MP3 and music players
- Phone accessories
- VoIP products
- Cordless headsets
- Aftermarket automotive applications

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Laird

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CATEGORIES	Feature	IMPLEMENTATION	
	Bluetooth®	Version 3.0	
Wireless Specification	Frequency	2.402 – 2.480 GHz	
	Max Transmit Power	Class 2 - 4 dBm (at antenna pad – BTM510)	
		4 dBmi (from integrated antenna – BTM511)	
	Receive Sensitivity	Better than -86 dBm	
	Range	Up to 30 meters	
	Data Rates	Up to 3 Mbps (over the air)	
	UART Data Transfer Rate	Greater than 300 Kbps	
Host Interface	UART	Supports DTR, DSR, DCD and RI, multiplexed with other functionality	
Audio Interfaces	Codec	Internal 16-bit Stereo Codec	
		Integrated Amplifiers for driving stereo speaker	
	I2S / PCM	Master / slave roles	
	Microphone	Stereo microphone input	
DSP	Integrated Kalimba DSP	32-bit, 64 MIPS	
Additional I/O	4 x GPIO	Function Mapping e.g. button control	
		SPP (Serial Port Profile), HSP, HFP v1.6 (Audio Gateway and Handset), A2DP	
Profiles		(Source and Sink), AVRCP v1.5 (Target and Controller)	
Currente Malt	Supply	3.0 V to +3.6 V DC	
Supply Voltage	I/O	1.7 V to +3.6 V DC	
	Current Consumption	Operational - Less than 70 mA (including speaker amplifiers)	
Power Consumption		Idle (sleep) < 1.0 mA	
		Configurable Sniff mode and Sniff sub rating	
Coexistence	802.11 (WLAN)	2 wire and 3 wire schemes supported	
	External Antenna	Connection via SMT pad – BTM510	
Connections	Internal Antenna	Multilayer ceramic – BTM511	
Programming API		AT Command Set (extended for audio and headset functions)	
Dhaired	Dimensions	14 mm x 20 mm x 3.4 mm (SMT connector – BTM510)	
Physical		14 mm x 25 mm x 3.4 mm (integrated antenna – BTM511)	
E au dive a vera e veta l	Operating Temperature	-40° C to +85° C	
Environmental	Storage Temperature	-40° C to +85° C	
	Lead Free	Lead-free and RoHS compliant	
Miscellaneous	Warranty	1-Year Warranty	
Developmental Tools	Development Kit	Development board and software tools	
	Bluetooth	End Product Approved	
Approvals	FCC/IC/CE & MIC	BTM510 - Limited Modular Approval	
		BTM511 - Full Modular Approval	

Ordering Information 🕴 🗸 RoHS

BTM510-09	Bluetooth Multimedia Module (external antenna)	
BTM511-09	Bluetooth Multimedia Module (with internal antenna)	
DVK-BTM510	Development Kit (external antenna)	
DVK-BTM511	Development Kit (with internal antenna)	

The details contained within the document are subject to change. Download the product specification from <u>www.lairdtech.com/wireless</u> for the most current specification.

CONN-DS-BTm510/511 FW v22.2.5.0

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Revision History

Ver	Date	Changes	Approved By
1.0	16 Jun 2013	Initial	J. Kaye

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